

Product/process change notification

PCN N° 2024-072-A

Dear customer,

Please find attached our Infineon Technologies AG PCN:

Transfer of the wafer production location to Infineon Technologies Kulim, Malaysia for dedicated GEN5 P-Channel MOSFET products

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before **2024-06-25**
- Infineon aligns with the widely recognized JEDEC STANDARD “**JESD46**“, which stipulates: **“Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change.”**

Your prompt reply will help Infineon to assure a smooth and well-executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG

Postal address D-81726 München Internet www.infineon.com Headquarters Am Campeon 1-15, D-85579 Neubiberg Phone +49 (0)89 234-0

Chairman of the Supervisory Board Dr. Herbert Diess

Management Board Jochen Hanebeck (CEO), Elke Reichart, Dr. Sven Schneider, Andreas Urschitz, Dr. Rutger Wijburg

Registered office Neubiberg Commercial register Amtsgericht München HRB 126492

Product/process change notification

PCN N° 2024-072-A

► **Products affected**

Please refer to attached affected product list
 “pcn_2024-072-A_[customer-no].pdf”

► **Detailed change information**

Subject Change of the wafer production location from Infineon Technologies Temecula, USA and EPISIL Technologies Inc., Taiwan to Infineon Technologies Kulim, Malaysia for dedicated G5 P-Channel MOSFET products

Reason The wafer production of the affected products will be transferred to Infineon Technologies Kulim, according to global Infineon production strategy

Description

	<u>Old</u>	<u>New</u>
Wafer Fab Location	<ul style="list-style-type: none"> ■ EPISIL Technologies Inc., Taiwan ■ Infineon Technologies Temecula, USA 	<ul style="list-style-type: none"> ■ Infineon Technologies Kulim, Malaysia
Wafer Diameter	<ul style="list-style-type: none"> ■ 150mm 	<ul style="list-style-type: none"> ■ 200mm
Wafer Frontside Metallization	<ul style="list-style-type: none"> ■ AISiCu (EPISIL) ■ AISI (Temecula) 	<ul style="list-style-type: none"> ■ AISiCu

► **Product identification**

Traceability is assured via Wafer lot number & country of diffusion
 Country of diffusion:

- **United States** = Infineon Technologies Temecula
- **Taiwan** = EPISIL Technologies Inc.
- **Malaysia** = Infineon Technologies Kulim

► **Impact of change**

NO change of electrical and thermal parameters as proven via product qualification and characterization. There is no change in form, fit and function

NO change in existing datasheet parameters

NO change in quality and reliability. Processes are optimized to meet product performance according to already applied Infineon specification.

Product/process change notification

PCN N° 2024-072-A

► Attachments

“pcn_2024-072-A_[customer-no].pdf” affected product list
2_cip24072_A qualification report

► Time schedule

- | | |
|------------------------------|------------|
| ■ Final qualification report | available |
| ■ First samples available | on request |
| ■ Intended start of delivery | 2024-08-15 |

If you have any questions, please do not hesitate to contact your local sales office.